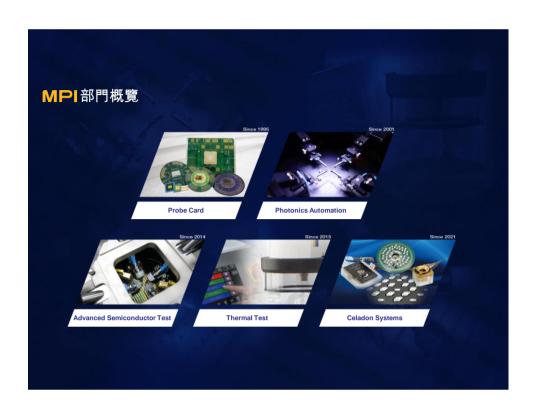


### 免責聲明

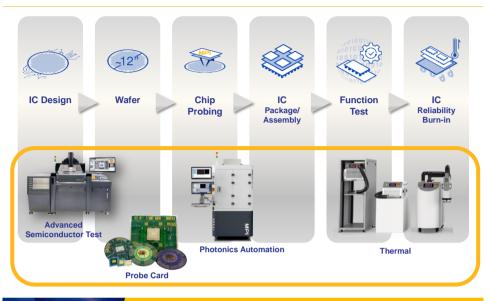
以下資訊包含前瞻性陳述,我們基於目前對未來事件的預期和預測做出了這些前瞻性陳述。儘管我們相信這些預期和預測是合理的,但這些前瞻性陳述本質上會受到以下風險和不確定性影響,包括但不限於:半導體和LED產業與市場的激烈競爭、半導體行業的週期性特性、全球業務活動所涉及的風險、整體經濟和政治環境。

此處討論的所有財務數字均根據國際財務報告準則(IFRS)編制·所有數字將在會計審計過程完成後公布。





# **MPI-The Powerhouse of Testing Solutions**



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## 議程

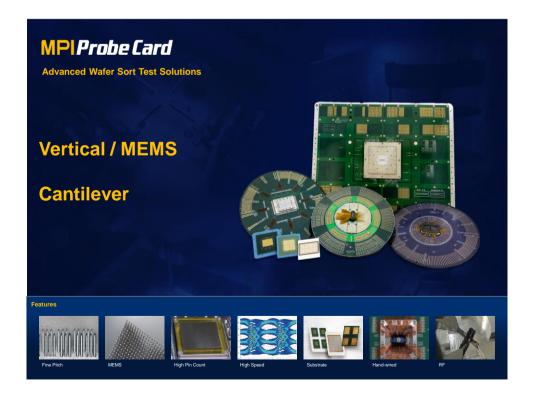


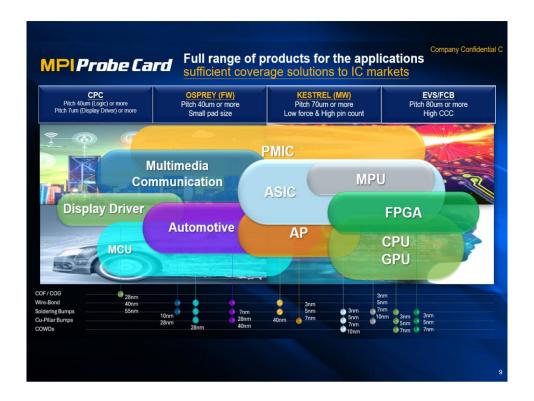
#### **Business Contents**

Probe Card
Photonics Automation
Thermal & AST

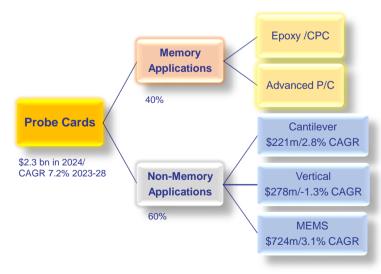






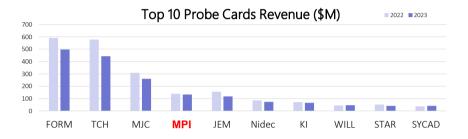


## 全球探針卡市場



# 自製IC探針卡供應商

(Rank)		2020	2021	2022	2023
FormFactor	USA	1	1	1	1
Technoprobe	Italy	2	2	2	2
Micronics Japan	Japan	3	3	3	3
MPI Corporation	Taiwan	5	5	5	4
Japan Electronic Materials	Japan	4	4	4	5



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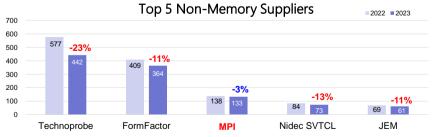
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Source: TechInsights

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## 前五大非記憶體探針卡供應商

(Rank)		2018	2019	2020	2021	2022	2023
Technoprobe	Italy	2	2	2	1	1	1
FormFactor, Inc.	USA	1	1	1	2	2	2
MPI Corporation	Taiwan	3	3	3	3	3	3
Japan Electronic Materials	Japan	4	5	5	4	5	5
Nidec SVTCL	Singapore	5	4	4	5	4	4



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urce: TechInsights

### Probe Card: 提供全方位解決方案

### • Comprehensive Product Range for Circuit Testing

#### 全方位的產品布局

MPI provides omnidirectional products to global customers, including <u>fine pitch CPC</u>, <u>high speed VPC</u> and <u>low force MEMS</u> solutions.

#### ● Solid Global Clientele 堅實的國際合作夥伴

MPI works closely with worldwide market leaders, especially for the AI, HPC application related.

#### ● Complete Probe Card Solution 完整的探針卡整合方案

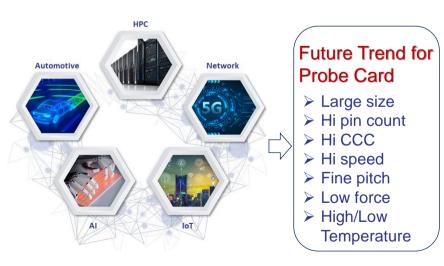
Provide <u>probe head</u>, <u>substrate</u>(MLO/MLC/MLOC) and <u>PCB</u> one-stop service.

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### 快速增長的應用層面



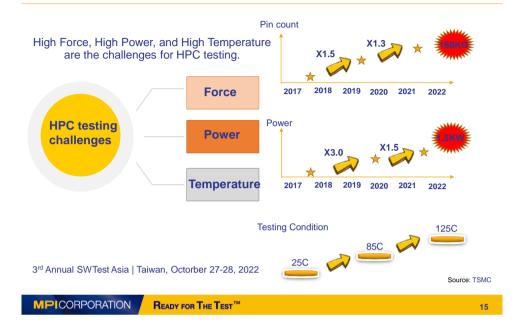
Source: TSMC

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Company Confidential B

## HPC挑戰



## **Interface Technical Complexity Check in**

Complexity Trends are on pace to be at 2022 targets( 1 Cycle) or in some cases beyond

"2x4 Scaling"=2xPins, 2xPerformance, every 4 years



	_		2018	2022	2026	
			Level 4	Level 5	Level 6	
		Pin Pitch	90um	70um	50um	
	Pin Density	Total Contact Force	80kg	150kg	250kg	
ľ	I/O Chand	Digital	32Gpbs	64Gpbs	128Gpbs	
	I/O Speed	RF/mmWave < 12 GHz 29		29 GHz	+60 GHz	
		Main Power	900 mV	750mV	625mV	
ì	Device	Single Rail	35A	50A	100A	
	Power	Impedance	2.2 mOhm	1.4 mOhm	0.8 mOhm	
		Self Heating	75 W			
	Thermal	Operating Range	0 to +80C	0 to +105C	-20 to +125C	
		t Expensive obe Card	\$400K*	>\$500K	>\$700K	

Source:Teradyne

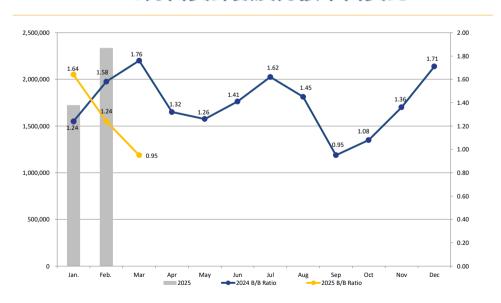
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## CPC月出貨針數及月接單出貨比



## VPC月出貨針數及月接單出貨比



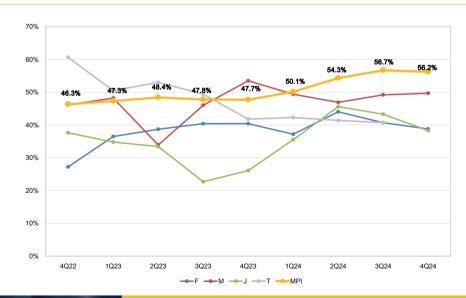
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## CPC及VPC成長趨勢



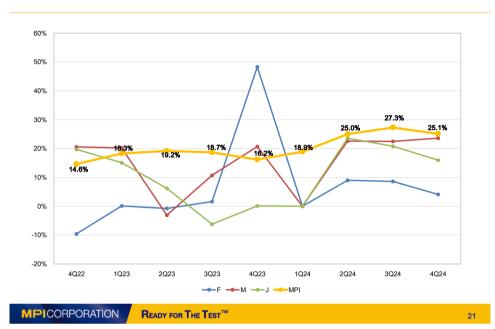
## 全球同業毛利率



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### 全球同業營利率







## 產品概覽



- High Power VCSEL Wafer Testing Wafer / Board Prober Development Testing methodology Development
- High Power VCSEL PKG Testing PKG Handler Development Testing methodology Development
- VCSEL / Photo-Detector Testing Wafer / Board Prober Development Testing methodology Development
- ➤ RF Character
  Wafer Level RF Testing Integration
- SiPh Die/PKG Platform SiPh Handler Development
- > uLED Mass Production Methodology
  Wafer prober for large quantity die testing method
- Panel testing platform development Panel / Panel in-process testing platform

### 發展計畫







Optical Sensing	Optical Communications	Micro Display
<ul> <li>Focus on Sensing VCSEL Testing</li> <li>Production Wafer Prober in Low Temperature</li> <li>High Power Measurement Tool and Technology Development</li> <li>Flip Chip Wafer VCSEL testing Solution</li> <li>Package / Hybrid Device testing tool</li> </ul>	<ul> <li>Focus on VCSEL/Photodetector Testing</li> <li>Wafer Prober for Dark / Responsivity / Capacity measurement</li> <li>RF Measurement Capability Development</li> <li>SiPh package testing approaching</li> </ul>	<ul> <li>Lab and production wafer testing tool development</li> <li>Contacting Accuracy Improvement</li> <li>Innovative testing methodology</li> <li>Optical measurement in production methodology</li> </ul>

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### PA:與市場領導者合作

#### ● Value Enhanced Product Lines 客戶價值導向的產品線規劃

MPI's experienced RD team comes across <u>lighting</u> and <u>electrical</u> fields with <u>automation</u> core technology that enables us to develop leading market solutions ie VCSEL & Micro LED.

#### ● Solid Global Clientele 穩固的全球客戶群

MPI works closely with market leaders and international brand names for most advanced testing solutions.

### ● Continuous Product Innovation 持續的產品創新

Non stop RD investments helps MPI to provide high value added products that tackles clients' testing bottleneck.





### Thermal: 客戶導向

- Innovational Temperature System 創新的溫度測試系統 Ongoing R&D investments in platforms and improvements leads MPI to meet customer demands. Thermal systems have a number of patents to provide efficient energy saving products that helps clients to fulfill ESG responsibility.
- Top Skillful RD Team 頂尖優秀專業的研發團隊

MPI's thermal solutions are developed by industry veterans with over 100 years of combined experience.

 Deep Cooperation with Leading Customers for Engineering and Production demand

與世界領導級大廠深度合作,提供工程及量產需求

Product application expands to automotive , 5G/RF communication , fiber optic , and sensing fields.

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### AST:獨特的市場領導者

#### ● Unique Global Position 全球獨特的市場地位

Combining Analytical probing solution and RF measurement core technology, MPI is top solution provider for full range hi-frequency response measurement.

#### ● VOC Design 客戶導向設計

Design based on Voice of the customer to full-fill customers' needs.

### ● Complete Solution 提供完整的解決方案

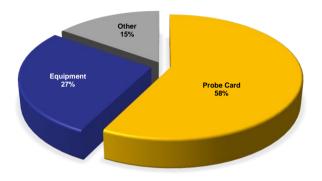
Various series of products to cover wide range applications include Device Modeling, RF & mmW, WLR, High-Power, Failure Analysis, Extreme temperature test ...etc.

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## 2024出貨分布

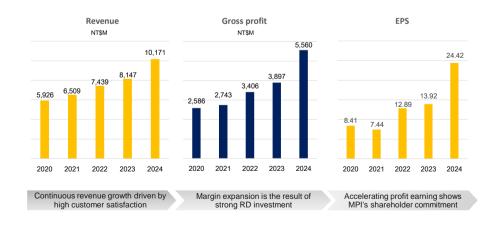


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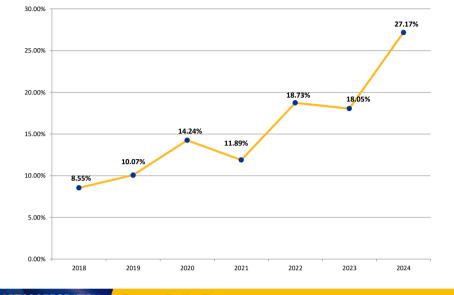
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## 營業表現



## 股東權益報酬率



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# 資產負債表

NT\$M	2024		2023	
Cash and Cash Equivalents	3,695	23%	2,579	21%
Fixed Assets	6,973	42%	5,536	45%
Total Assets	16,479	100%	12,440	100%
LT Debt	1,305	8%	1,511	12%
Shareholders' Equity	9,307	56%	7,620	61%
EBITDA	2,795	28%	1,582	19%

\*EBITDA=operating income + depreciation & amortization expenses

# 綜合損益表

NT\$000	2024		2023	3	
Net Sales	10,171,861	100%	8,147,112	100%	
Cost of Goods Sold	4,610,891	45%	4,250,049	52%	
Gross Profit	5,560,970	55%	3,897,063	48%	
Operating Expense	3,078,298	30%	2,425,698	30%	
Operating Income	2,482,672	25%	1,471,365	18%	
Investment Income & Others	312,044		110,930		
Net Income (after tax)	2,299,887	23%	1,309,575	16%	
EPS (after tax)	24.42		13.92		
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